

Overview

The KEMET Organic Capacitor (KO-CAP) is a tantalum capacitor with a Ta anode and Ta₂O₅ dielectric. A conductive organic polymer replaces the traditionally used MnO₂ as the cathode plate of the capacitor. This results in very low ESR and improved capacitance retention at high frequency. The KO-CAP also exhibits a benign failure mode which eliminates the ignition failures that can occur in standard MnO₂ tantalum types. KO-CAPs may also be operated at steady state voltages up to 90% of rated voltage for part types with rated voltages of ≤10 volts and up to 80% of rated voltage for part types >10 volts with equivalent or better reliability than traditional MnO₂ tantalum capacitors operated at 50% of rated voltage.

The T525 Series KO-CAP Low ESR Polymer is KEMET's 125°C rated tantalum polymer capacitor. This part offers the same advantages as the T520 Series such as low ESR, high frequency capacitance retention and a benign failure mode. The T525 Series is often the series of choice when considering automotive or industrial type applications.

Benefits

- Polymer cathode technology
- 125°C maximum operating temperature
- High frequency capacitance retention
- Non-ignition failure mode
- Capacitance: 33µF to 680µF
- Voltage: 2.5V to 16V
- Use up to 90% of rated voltage (10% derating) for part types ≤10V
- Use up to 80% of rated voltage (20% derating) for part types >10V
- 100% surge current tested
- Self-healing mechanism
- Volumetrically efficient
- EIA standard case sizes
- RoHS compliant and Halogen Free

Applications

Typical applications include automotive, industrial and military as per DSCC 04051.



Environmental Compliance

RoHS Compliant (6/6)* according to Directive 2002/95/EC

*When ordered with 100% Sn Solder

SPICE

For a detailed analysis of specific part numbers, please visit kemet.com for a free download of KEMET's SPICE software. The KEMET SPICE program is freeware intended to aid design engineers in analyzing the performance of these capacitors over frequency, temperature, ripple, and DC bias conditions.

Ordering Information

T	525	D	337	M	006	A	T	E025	
Capacitor Class	Series	Case Size	Capacitance Code (pF)	Capacitance Tolerance	Voltage	Failure Rate/Design	Lead Material	ESR Code	Packaging (C-Spec)
T = Tantalum	525 = 125°C Rated Polymer	B = 3528-21 D = 7343-31 T = 3528-12 V = 7343-20 Y = 7343-40	First two digits represent significant figures. Third digit specifies number of zeros.	M = ±20%	2R5 = 2.5V 003 = 3V 004 = 4V 006 = 6.3V 010 = 10V 016 = 16V	A = N/A	T = 100% Matte Tin (Sn) Plated H = Tin/Lead (SnPb) Solder Coated (5% Pb minimum)	E = ESR Last three digits specify ESR in mOhms. (025 = 25mOhms)	Blank = 7" Reel 7280 = 13" Reel

Performance Characteristics

Item	Performance Characteristics
Operating Temperature	-55°C to 125°C
Rated Capacitance Range	22µF - 680µF @ 120 Hz/25°C
Capacitance Tolerance	M Tolerance (20%)
Rated Voltage Range	2.5V - 16V
DF(120Hz)	≤ 10%
ESR (100kHz)	Refer to Part Number Electrical Specification Table
Leakage Current	≤ 0.1CV (µA) at Rated Voltage after 5 minutes

Qualification

Test	Condition	Characteristics				
Endurance	125°C @ 2/3 Rated Voltage, 2000 Hrs.	$\Delta C/C$	Within -20/+10% of initial value			
		DF	\leq Initial Limit			
		DCL	2x IL @ 125° C			
		ESR	2x Initial Limit			
Storage Life	125°C @ 0 Volts, 2000 Hrs.	$\Delta C/C$	Within -20/+10% of initial value			
		DF	Within initial limits			
		DCL	Within 2.0 x initial limit			
		ESR	2x Initial Limit			
Humidity	60°C, 90% RH, 1000Hr, No Load	$\Delta C/C$	Within -5%/+35% of initial value			
		DF	\leq Initial Limit			
		DCL	Within 3.0 x initial limit			
Temperature Stability	Extreme temperature exposure at a succession of continuous steps at +25°C, -55°C, +25°C, +85°C, +125°C, +25°C.		+25°C	-55°C	+85°C	+125°C
		$\Delta C/C$	IL*	$\pm 20\%$	$\pm 20\%$	$\pm 30\%$
		DF	IL	IL	1.2 x IL	1.5 x IL
Surge Voltage	105°C, 1.32 x Rated Voltage, 33 Ω Resistance, 1000 cycles	$\Delta C/C$	Within -20/+10% of initial value			
		DF	Within initial limits			
		DCL	Within initial limits			
Mechanical Shock/Vibration	Mil-Std-202, Meth. 213, Cond. I, 100G Peak Mil-Std-202, Meth. 204, Cond. D, 10Hz to 2000Hz, 20G Peak	$\Delta C/C$	Within $\pm 10\%$ of initial value			
		DF	Within initial limits			
		DCL	Within initial limits			

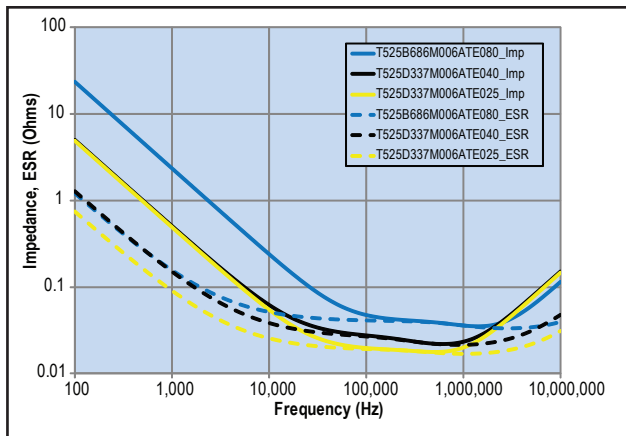
*IL = Initial Limit

Certification

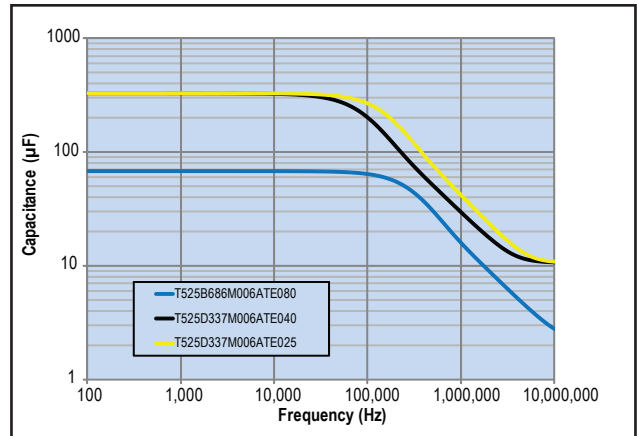
DSCC Drawing 04051

Electrical Characteristics

ESR vs. Frequency

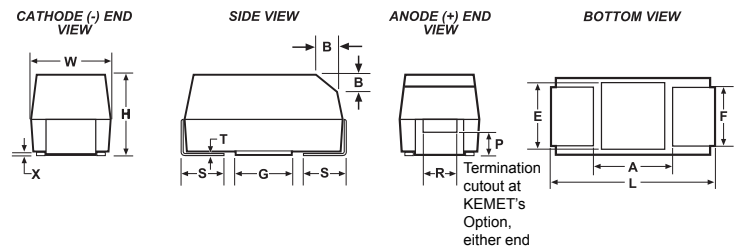


Capacitance vs. Frequency



Dimensions – Millimeters (Inches)

Metric will govern



Case Size		Component												
KEMET	EIA	L*	W*	H*	F* ±0.1 ±(.004)	S* ±0.3 ±(.012)	B* ±0.15 (Ref) ±.006	X (Ref)	P (Ref)	R (Ref)	T (Ref)	A (Min)	G (Ref)	E (Ref)
B	3528-21	3.5 ± 0.2 (.138 ± .008)	2.8 ± 0.2 (.110 ± .008)	1.9 ± 0.2 (.075 ± .008)	2.2 (.087)	0.8 (.031)	0.4 (.016)	0.10 ± 0.10 (.004 ± .004)	0.5 (.020)	1.0 (.039)	0.13 (.005)	2.1 (.083)	1.8 (.071)	2.2 (.087)
D	7343-31	7.3 ± 0.3 (.287 ± .012)	4.3 ± 0.3 (.169 ± .012)	2.8 ± 0.3 (.098 ± .012)	2.4 (.094)	1.3 (.051)	0.5 (.020)	0.10 ± 0.10 (.004 ± .004)	0.9 (.035)	1.0 (.039)	0.13 (.005)	3.8 (.150)	3.5 (.138)	3.5 (.138)
T	3528-12	3.5 ± 0.2 (.138 ± .008)	2.8 ± 0.2 (.110 ± .008)	1.2 (.047) max	2.2 (.087)	0.8 (.031)	N/A	0.05 (.002)	N/A	N/A	0.13 (.005)	2.1 (.083)	1.8 (.071)	2.2 (.087)
V	7343-20	7.3 ± 0.3 (.287 ± .012)	4.3 ± 0.3 (.169 ± .012)	1.9 (.075) max	2.4 (.094)	1.3 (.051)	N/A	0.05 (.002)	N/A	N/A	0.13 (.005)	3.8 (.150)	3.5 (.138)	3.5 (.138)
Y	7343-40	7.3 ± 0.3 (.287 ± .012)	4.3 ± 0.3 (.169 ± .012)	4.0 (.157) max	2.4 (.094)	1.3 (.051)	0.5 (.020)	0.10 ± 0.10 (.004 ± .004)	1.7 (.067)	1.0 (.039)	0.13 (.005)	3.8 (.150)	3.5 (.138)	3.5 (.138)

Notes: (Ref) – Dimensions provided for reference only. No dimensions provided for B, P or R because low profile cases do not have a bevel or a notch.

*MIL-C-55365/8 specified dimensions

Table 1 – Ratings & Part Number Reference

Rated Voltage	Rated Cap	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	ESR	Maximum Allowable Ripple Current	Moisture Sensitivity	Rated Temp
VDC	120Hz	KEMET/EIA	(See below for part options)	+20°C	+20°C 120Hz	+20°C 100kHz	+45°C 100kHz	Temp≤260°C J-STD-020D	(°C)
	µF			µAmps	% Max	mOhms	mAmps		
2.5	100	T/3528-12	T525T107M2R5A(1)E080	25.0	10	80	1100.0	3	125
2.5	330	D/7343-31	T525D337M2R5A(1)E025	82.5	10	25	3000.0	3	125
2.5	470	D/7343-31	T525D477M2R5A(1)E025	117.5	10	25	3000.0	3	125
2.5	680	D/7343-31	T525D687M2R5A(1)E025	170.0	10	25	3000.0	3	125
3	100	B/3528-21	T525B107M003A(1)E080	30.0	8	80	1300.0	3	125
3	150	B/3528-21	T525B157M003A(1)E080	45.0	8	80	1300.0	3	125
3	330	D/7343-31	T525D337M003A(1)E025	99.0	10	25	3000.0	3	125
3	470	D/7343-31	T525D477M003A(1)E025	141.0	10	25	3000.0	3	125
3	680	D/7343-31	T525D687M003A(1)E025	204.0	10	25	3000.0	3	125
4	68	T/3528-12	T525T686M004A(1)E080	27.2	8	80	1100.0	3	125
4	68	B/3528-21	T525B686M004A(1)E080	27.2	8	80	1300.0	3	125
4	100	B/3528-21	T525B107M004A(1)E080	40.0	8	80	1300.0	3	125
4	220	D/7343-31	T525D227M004A(1)E025	88.0	10	25	3000.0	3	125
4	330	D/7343-31	T525D337M004A(1)E025	132.0	10	25	3000.0	3	125
4	470	D/7343-31	T525D477M004A(1)E025	188.0	10	25	3000.0	3	125
4	470	D/7343-31	T525D477M004A(1)E040	188.0	10	40	2400.0	3	125
6.3	33	B/3528-21	T525B336M006A(1)E080	20.8	8	80	1300.0	3	125
6.3	47	T/3528-12	T525T476M006A(1)E080	29.6	8	80	1100.0	3	125
6.3	47	B/3528-21	T525B476M006A(1)E070	29.6	8	70	1300.0	3	125
6.3	47	B/3528-21	T525B476M006A(1)E080	29.6	8	80	1300.0	3	125
6.3	68	B/3528-21	T525B686M006A(1)E080	42.8	8	80	1300.0	3	125
6.3	150	D/7343-31	T525D157M006A(1)E025	94.5	10	25	3000.0	3	125
6.3	220	D/7343-31	T525D227M006A(1)E025	138.6	10	25	3000.0	3	125
6.3	330	D/7343-31	T525D337M006A(1)E025	207.9	10	25	3000.0	3	125
6.3	330	D/7343-31	T525D337M006A(1)E040	207.9	10	40	2400.0	3	125
6.3	470	Y/7343-40	T525Y477M006A(1)E035	296.1	10	35	2600.0	3	125
8	33	T/3528-12	T525T336M008A(1)E080	26.4	8	80	1100.0	3	125
10	22	B/3528-21	T525B226M010A(1)E080	22.0	8	80	1300.0	3	125
10	33	T/3528-12	T525T336M010A(1)E080	33.0	8	80	1100.0	3	125
10	33	B/3528-21	T525B336M010A(1)E080	33.0	8	80	1300.0	3	125
10	100	D/7343-31	T525D107M010A(1)E025	100.0	10	25	3000.0	3	125
10	100	D/7343-31	T525D107M010A(1)E055	100.0	10	55	2000.0	3	125
10	150	D/7343-31	T525D157M010A(1)E025	150.0	10	25	3000.0	3	125
10	150	D/7343-31	T525D157M010A(1)E055	150.0	10	55	2000.0	3	125
10	220	D/7343-31	T525D227M010A(1)E025	220.0	10	25	3000.0	3	125
10	330	Y/7343-40	T525Y337M010A(1)E035	330.0	10	35	2600.0	3	125
16	47	D/7343-31	T525D476M016A(1)E035	75.2	10	35	2500.0	3	125
16	47	D/7343-31	T525D476M016A(1)E065	75.2	10	65	1900.0	3	125
VDC	µF	KEMET/EIA	(see below for part options)	µAmps	% Max	mOhms	mAmps	J-STD-020D Temp≤260°C	(°C)
	120Hz			+20°C	+20°C 120Hz	+20°C 100kHz	+45°C 100kHz		
Rated Voltage	Rated Cap	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	ESR	Maximum allowable ripple current	Moisture Sensitivity	Rated Temp

Other part number options:

1- Standard with tin terminations (14th character = T). Tin/lead terminations is also available (14th character = H)

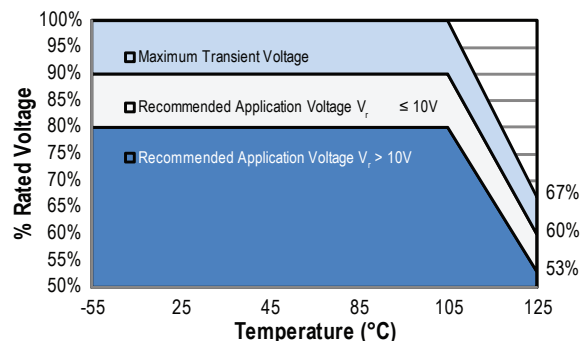
Also available on large (13 inch) reels. Add 7280 to the end of the part number.

Higher voltage ratings and tighter tolerance product including ESR may be substituted within the same size at KEMET's option. Voltage substitutions will be marked with the higher voltage rating. Substitutions can include better than series.

Derating Guidelines

Voltage Rating	Max Recommended Steady State Voltage	Max Recommended Transient Voltage (1ms - 1μs)
-55°C to 105°C		
$2.5V \leq V_r \leq 10V$	90% of V_r	V_r
$12.5V \leq V_r \leq 25V$	80% of V_r	V_r
105°C to 125°C		
$2.5V \leq V_r \leq 10V$	60% of V_r	67% of V_r
$12.5V \leq V_r \leq 25V$	54% of V_r	67% of V_r

V_r = Rated Voltage



Ripple Current/Ripple Voltage

Permissible AC ripple voltage and current are related to equivalent series resistance (ESR) and the power dissipation capabilities of the device. Permissible AC ripple voltage which may be applied is limited by two criteria:

- The positive peak AC voltage plus the DC bias voltage, if any, must not exceed the DC voltage rating of the capacitor.
- The negative peak AC voltage, in combination with bias voltage, if any, must not exceed the allowable limits specified for reverse voltage.

The maximum power dissipation by case size can be determined using the below table. The maximum power dissipation rating stated in the table above must be reduced with increasing environmental operating temperatures. Refer to the below table for temperature compensation requirements.

Case Code		Maximum Power Dissipation (Pmax) mWatts @ 45°C w/+30°C Rise
KEMET	EIA	
T520/525T	3528-12	105
T520M	3528-15	120
T520A	3216-18	112
T520/525B	3538-21	127
T520U	6032-15	135
T520L	3528-19	150
T520C	6032-28	165
T520W	7343-15	180
T520V	7343-20	187
T520/525D	7343-31	225
T520Y	7343-40	241
T520X	7343-43	247
T528Z	7343-17	325
T530D	7343-31	255
T530Y	7343-40	263
T530X	7443-43	270

Temperature Compensation Multipliers for Maximum Power Dissipation		
$\leq 45^\circ\text{C}$	$45^\circ\text{C} < T \leq 85^\circ\text{C}$	$85^\circ\text{C} < T \leq 105^\circ\text{C}$
1.00	0.70	0.25

T = Environmental Temperature

Using the P max of the device, the maximum allowable rms ripple current or voltage may be determined.

$$I(\text{max}) = \sqrt{P_{\text{max}}/R}$$

$$E(\text{max}) = \sqrt{P_{\text{max}} \cdot R}$$

I = rms ripple current (amperes)

E = rms ripple voltage (volts)

P_{max} = maximum power dissipation (watts)

R = ESR at specified frequency (ohms)

Reverse Voltage

Polymer tantalum capacitors are polar devices and may be permanently damaged or destroyed if connected in the wrong polarity. These devices will withstand a small degree of transient voltage reversal for short periods as shown in the below table.

Temperature	Permissible Transient Reverse Voltage
25°C	15% of Rated Voltage
55°C	10% of Rated Voltage
85°C	5% of Rated Voltage
105°C	3% of Rated Voltage
125°C*	1% of Rated Voltage

*For Series Rated to 125°C

Table 2 – Land Dimensions/Courtyard

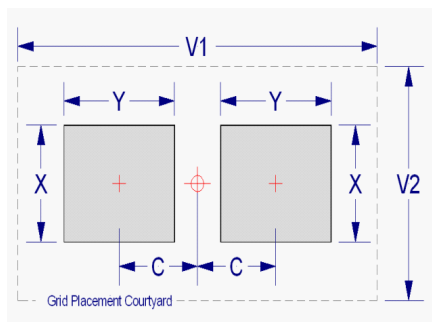
KEMET	Metric Size Code	Density Level A: Maximum (Most) Land Protrusion (mm)					Density Level B: Median (Nominal) Land Protrusion (mm)					Density Level C: Minimum (Least) Land Protrusion (mm)						
		Case	EIA	X	Y	C	V1	V2	X	Y	C	V1	V2	X	Y	C	V1	V2
		B	3528-21	2.35	2.15	1.45	6.10	4.00	2.25	1.75	1.35	5.00	3.50	2.15	1.35	1.25	4.10	3.20
		D	7343-31	2.55	3.75	2.70	10.20	5.50	2.45	3.35	2.60	9.10	5.00	2.35	2.95	2.50	8.20	4.70
		T	3528-12	2.35	2.15	1.45	6.10	4.00	2.25	1.75	1.35	5.00	3.50	2.15	1.35	1.25	4.10	3.20
		V	7343-20	2.55	3.75	2.70	10.20	5.50	2.45	3.35	2.60	9.10	5.00	2.35	2.95	2.50	8.20	4.70
		Y ¹	7343-35	2.55	3.75	2.70	10.20	5.50	2.45	3.35	2.60	9.10	5.00	2.35	2.95	2.50	8.20	4.70

Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes.

Density Level C: For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC standard 7351 (IPC-7351).

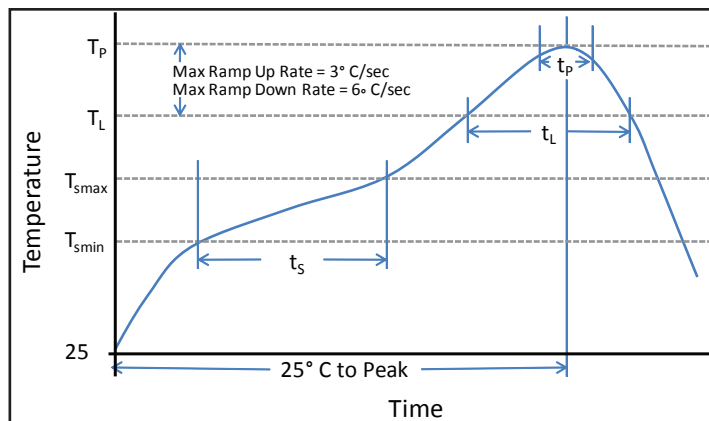
¹ Height of these chips may create problems in wave soldering.



Soldering Process

KEMET's families of surface mount tantalum capacitors are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020D standard for moisture sensitivity testing. The devices can safely withstand a maximum of three reflow passes at these conditions.

Note that although the X/7343-43 case size can withstand wave soldering, the tall profile (4.3mm maximum) dictates care in wave process development.



Time/Temperature Soldering Profile

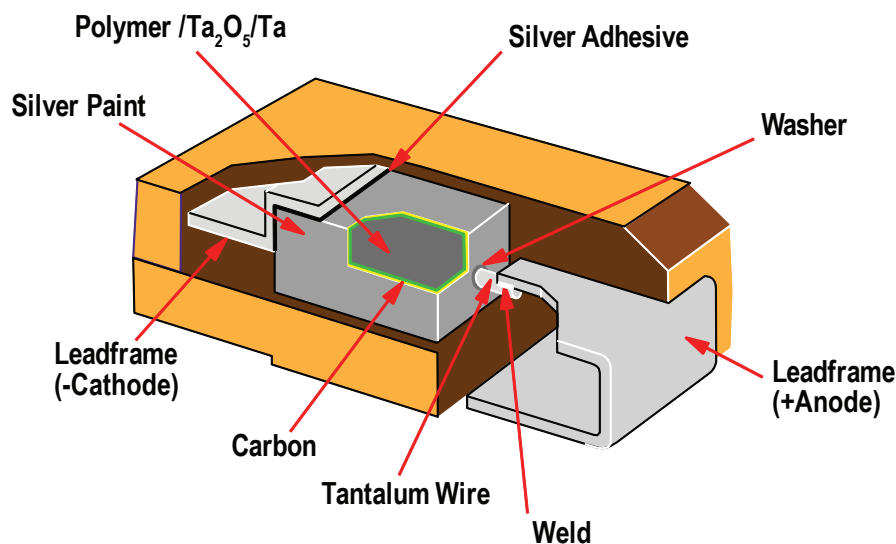
Profile Feature	Sn-Pb Assembly	Pb-Free Assembly
Preheat/Soak		
Temperature Min (T_{smin})	100°C	150°C
Temperature Max (T_{smax})	150°C	200°C
Time (t_s) from T_{smin} to T_{smax}	60-120 sec	60-120 sec
Ramp-up rate (T_L to T_p)	3°C/sec max	3°C/sec max
Liquidous temperature (T_L)	183°C	217°C
Time above liquidous (t_L)	60-150 sec	60-150 sec
Peak Temperature (T_p)	220°C* 235°C**	250°C* 260°C**
Time within 5°C of max peak temperature (t_p)	20 sec max	30 sec max
Ramp-down rate (T_p to T_L)	6°C/sec max	6°C/sec max
Time 25°C to peak temperature	6 minutes max	8 minutes max

Note 1: All temperatures refer to the center of the package, measured on the package body surface that is facing up during assembly reflow.

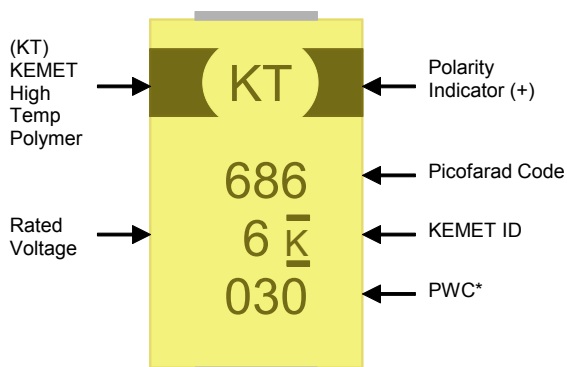
* Case Size D, E, P, Y and X

**Case Size A, B, C, H, I, K, M, R, S, T, U, V, W and Z

Construction



Capacitor Marking



* 030 = 30th week of 2010

Storage

All KO-Cap series are shipped in moisture barrier bags with a desiccant and moisture indicator card. These series are classified as MSL3 (Moisture Sensitivity Level 3).

Product contained within the moisture barrier bags should be stored in normal working environments with temperatures not to exceed 40°C and humidity not in excess of 60% RH.

Tape & Reel Packaging Information

KEMET's Molded Tantalum and Aluminum Chip Capacitor families are packaged in 8 mm and 12 mm plastic tape on 7" and 13" reels, in accordance with EIA Standard 481-1: Taping of Surface Mount Components for Automatic Handling. This packaging system is compatible with all tape fed automatic pick and place systems.

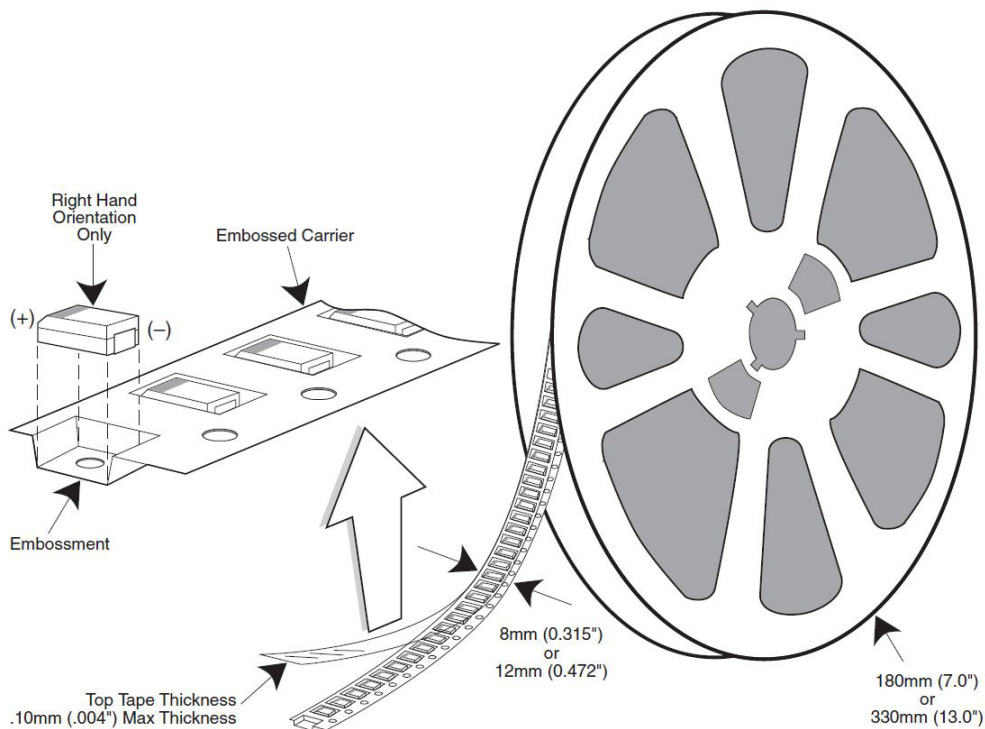


Table 4 – Packaging Quantity

Case Code		Tape Width-mm	7" Reel*	13" Reel*
KEMET	EIA			
R	2012-12	8	2,500	10,000
I	3216-10	8	3,000	12,000
S	3216-12	8	2,500	10,000
T	3528-12	8	2,500	10,000
M	3528-15	8	2,000	8,000
U	6032-15	12	1,000	5,000
L	6032-19	12	1,000	5,000
W	7343-15	12	1,000	3,000
Z	7343-17	12	1,000	3,000
V	7343-20	12	1,000	3,000
A	3216-18	8	2,000	9,000
B	3528-21	8	2,000	8,000
C	6032-28	12	500	3,000
D	7343-31	12	500	2,500
Y	7343-40	12	500	2,000
X	7343-43	12	500	2,000
E	7260-38	12	500	2,000

* No c-spec required for 7" reel packaging. C-7280 required for 13" reel packaging.

Figure 1 – Embossed (Plastic) Carrier Tape Dimensions

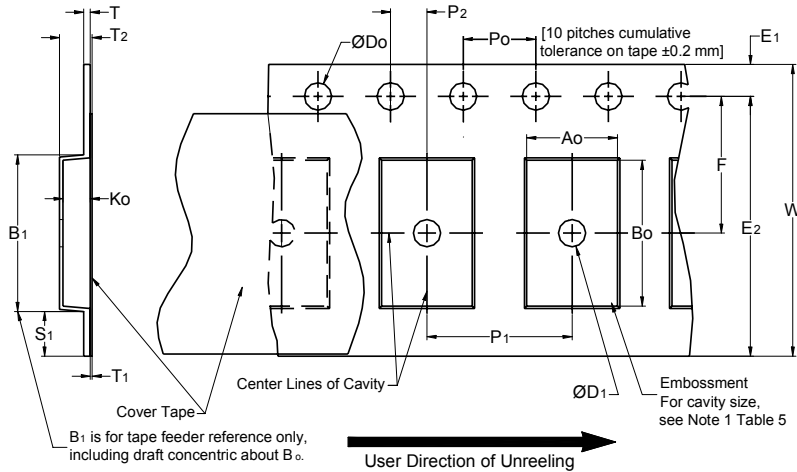


Table 5 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)									
Tape Size	D_0	D_1 Min. Note 1	E_1	P_0	P_2	R Ref. Note 2	S_1 Min. Note 3	T Max.	T_1 Max.
8mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.0 (0.039)	1.75 ± 0.10 (0.069 ± 0.004)	4.0 ± 0.10 (0.157 ± 0.004)	2.0 ± 0.05 (0.079 ± 0.002)	25.0 (0.984)	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)
12mm		1.5 (0.059)				30 (1.181)			
16mm									
Variable Dimensions — Millimeters (Inches)									
Tape Size	Pitch	B_1 Max. Note 4	E_2 Min.	F	P_1	T_2 Max	W Max	A_0, B_0 & K_0	
8mm	Single (4mm)	4.35 (0.171)	6.25 (0.246)	3.5 ± 0.05 (0.138 ± 0.002)	4.0 ± 0.10 (0.157 ± 0.004)	2.5 (0.098)	8.3 (0.327)	Note 5	
12mm	Single (4mm) & Double (8mm)	8.2 (0.323)	10.25 (0.404)	5.5 ± 0.05 (0.217 ± 0.002)	8.0 ± 0.10 (0.315 ± 0.004)	4.6 (0.181)	12.3 (0.484)		
16mm	Triple (12mm)	12.1 (0.476)	14.25 (0.561)	5.5 ± 0.05 (0.217 ± 0.002)	8.0 ± 0.10 (0.315 ± 0.004)	4.6 (0.181)	16.3 (0.642)		

1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.
2. The tape with or without components shall pass around R without damage (see Figure 5).
3. If $S_1 < 1.0$ mm, there may not be enough area for cover tape to be properly applied (see EIA Document 481 paragraph 4.3 (b)).
4. B_1 dimension is a reference dimension for tape feeder clearance only.
5. The cavity defined by A_0 , B_0 and K_0 shall surround the component with sufficient clearance that:
 - (a) the component does not protrude above the top surface of the carrier tape.
 - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - (c) rotation of the component is limited to 20° maximum for 8 and 12mm tapes and 10° maximum for 16mm tapes (see Figure 3).
 - (d) lateral movement of the component is restricted to 0.5 mm maximum for 8mm and 12mm wide tape and to 1.0mm maximum for 16mm tape (see Figure 4).
 - (e) for KPS Series product A_0 and B_0 are measured on a plane 0.3mm above the bottom of the pocket.
 - (f) see Addendum in EIA Document 481 for standards relating to more precise taping requirements.

Packaging Information Performance Notes

1. **Cover Tape Break Force:** 1.0 Kg Minimum.
2. **Cover Tape Peel Strength:** The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength
8mm	0.1 Newton to 1.0 Newton (10gf to 100gf)
12mm & 16mm	0.1 Newton to 1.3 Newton (10gf to 130gf)

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300±10 mm/minute.

3. **Labeling:** Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. Refer to EIA-556 and EIA-624.

Figure 3 – Maximum Component Rotation

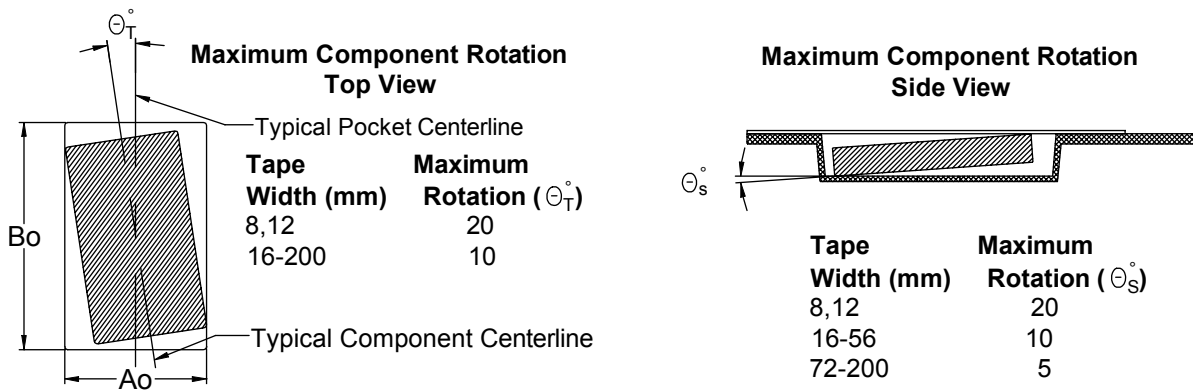


Figure 4 – Maximum Lateral Movement

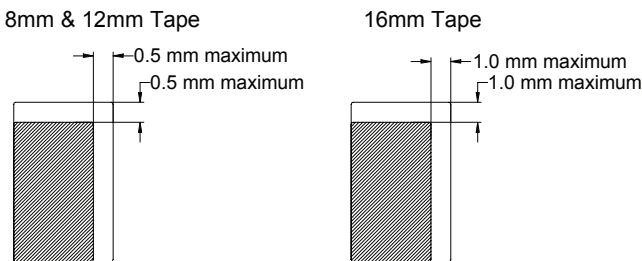


Figure 5 – Bending Radius

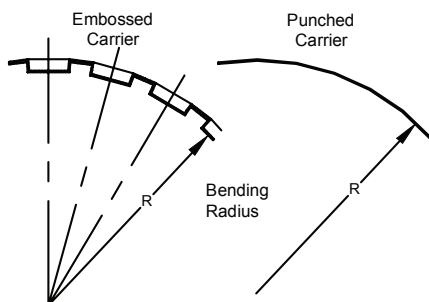
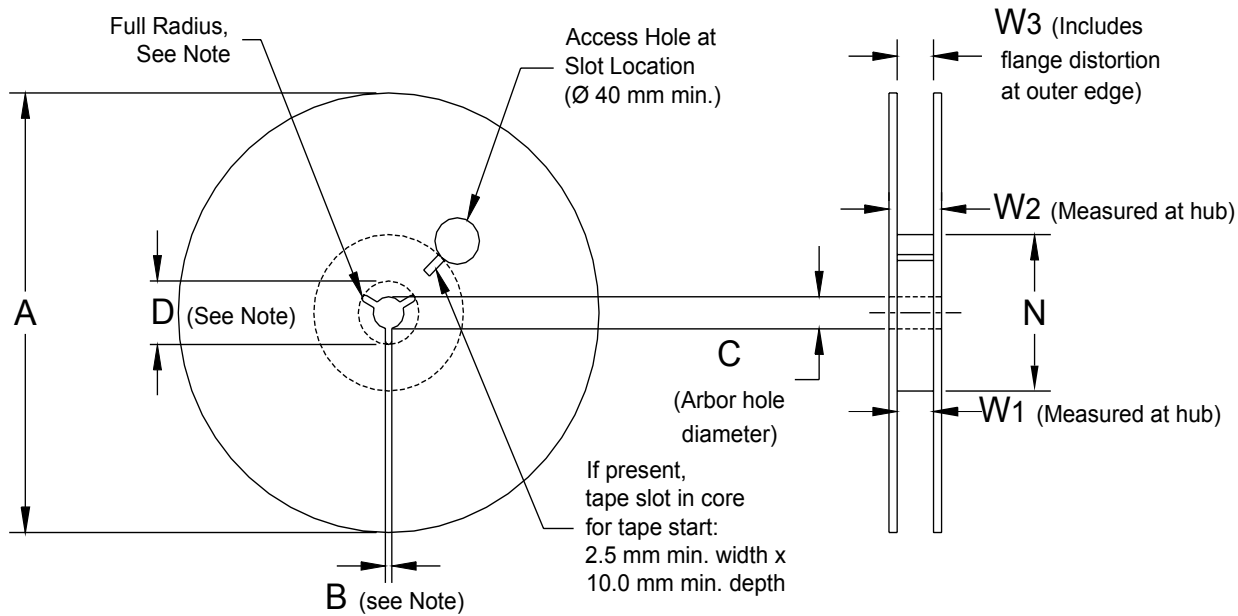


Figure 6 – Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

Table 7 – Reel Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)				
Tape Size	A	B Min	C	D Min
8mm	178 ± 0.20 (7.008 ± 0.008)	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)
12mm	or			
16mm	330 ± 0.20 (13.000 ± 0.008)			
Variable Dimensions — Millimeters (Inches)				
Tape Size	N Min	W ₁	W ₂ Max	W ₃
8mm	50 (1.969)	8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)	Shall accommodate tape width without interference
12mm		12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	
16mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)	

Figure 7 – Tape Leader & Trailer Dimensions

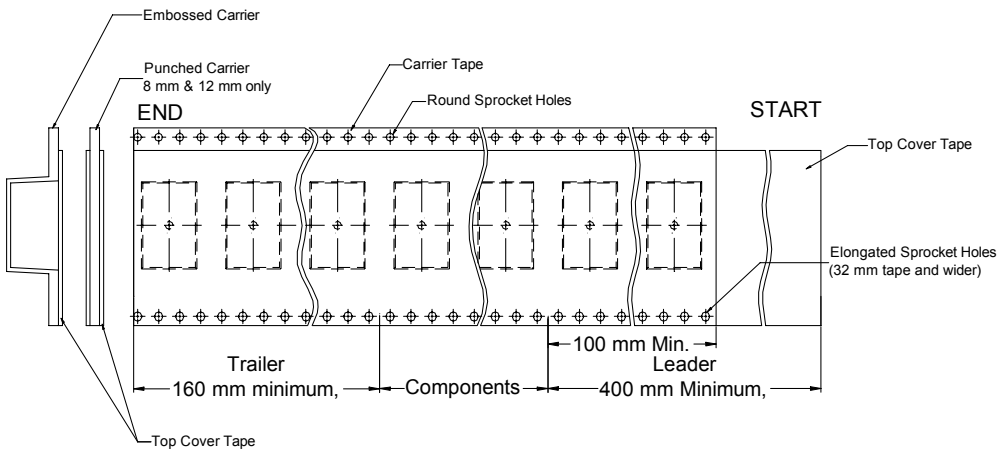
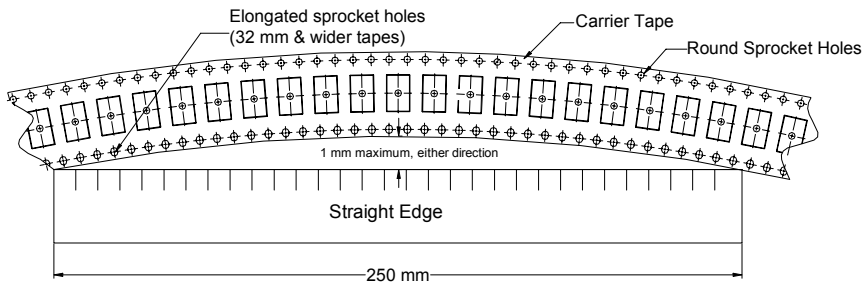


Figure 8 – Maximum Camber



Other KEMET Resources

Tools	
Resource	Location
Configure A Part: CapEdge	http://capacitoredge.kemet.com
SPICE & FIT Software	http://www.kemet.com/spice
Search Our FAQs: KnowledgeEdge	http://www.kemet.com/keask

Product Information	
Resource	Location
Products	http://www.kemet.com/products
Technical Resources (Including Soldering Techniques)	http://www.kemet.com/technicalpapers
RoHS Statement	http://www.kemet.com/rohs
Quality Documents	http://www.kemet.com/qualitydocuments

Product Request	
Resource	Location
Sample Request	http://www.kemet.com/sample
Engineering Kit Request	http://www.kemet.com/kits

Contact	
Resource	Location
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Contact Us	http://www.kemet.com/contact
Investor Relations	http://www.kemet.com/ir
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Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicated or that other measures may not be required.

KEMET Corporation World Headquarters

2835 KEMET Way
Simpsonville, SC 29681

Mailing Address:
P.O. Box 5928
Greenville, SC 29606

www.kemet.com
Tel: 864-963-6300
Fax: 864-963-6521

Corporate Offices

Fort Lauderdale, FL
Tel: 954-766-2800

North America

Southeast

Lake Mary, FL
Tel: 407-855-8886

Northeast

Wilmington, MA
Tel: 978-658-1663

West Chester, PA
Tel: 610-692-4642

Central

Schaumburg, IL
Tel: 847-882-3590

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Tel: 317-706-6742

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Milpitas, CA
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Zapopan, Jalisco
Tel: 52-33-3123-2141

Europe

Southern Europe

Geneva, Switzerland
Tel: 41-22-715-0100

Paris, France
Tel: 33-1-4646-1009

Sasso Marconi, Italy
Tel: 39-051-939111

Milan, Italy
Tel: 39-02-57518176

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Tel: 39-06-23231718

Madrid, Spain
Tel: 34-91-804-4303

Central Europe

Landsberg, Germany
Tel: 49-8191-3350800

Dortmund, Germany
Tel: 49-2307-3619672

Kwidzyn, Poland
Tel: 48-55-279-7025

Northern Europe

Bishop's Stortford, United Kingdom
Tel: 44-1279-757201

Weymouth, United Kingdom
Tel: 44-1305-830747

Coatbridge, Scotland
Tel: 44-1236-434455

Färjestaden, Sweden
Tel: 46-485-563934

Espoo, Finland
Tel: 358-9-5406-5000

Asia

Northeast Asia

Hong Kong
Tel: 852-2305-1168

Shenzhen, China
Tel: 86-755-2518-1306

Beijing, China
Tel: 86-10-5829-1711

Shanghai, China
Tel: 86-21-6447-0707

Taipei, Taiwan
Tel: 886-2-27528585

Southeast Asia

Singapore
Tel: 65-6586-1900

Penang, Malaysia
Tel: 60-4-6430200

Bangalore, India
Tel: 91-806-53-76817

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